PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Tse-Hua Yao	06/20/2019
Yi-Fan Chen	06/20/2019

RECEIVING PARTY DATA

Name:	Elite Semiconductor Memory Technology Inc.
Street Address:	No 23, Industry E. Road IV, Hsinchu Science Park
City:	Hsinchu
State/Country:	TAIWAN

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	16576727

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ATTORNEY DOCKET NUMBER:	ESMP0113USA4
NAME OF SUBMITTER:	SIBYL YU
SIGNATURE:	/SIBYL YU/
DATE SIGNED:	09/19/2019

Total Attachments: 4

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> PATENT REEL: 050438 FRAME: 0916

505681878

COMBINE DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION USING AN APPLICATION DATA SHEET (37 CFR 1.76) AND ASSIGNMENT

Title of Invention: E-FUSE BURNING CIRCUIT AND E-FUSE BURNING METHOD

As the below named inventor, I herel This declaration is directed to:	by declare that:		
☑ The attached application, or			
☐ United States application nu	mber	filed on	_, or
☐ PCT international application	number	filed on	
The above-identified application was	made or authorized to be made	by me.	
I believe that I am the original inventage application.	or or an original joint inventor of	a claimed invention in the	
I hereby acknowledge that any willfuunder18 U.S.C. 1001 by fine or impr			
In consideration of the payment by	Elite Semiconductor Mem Technology Inc.	nory having a postal ad	dress of
No 23, Industry E. Road IV, H	sinchu Science Park, Hsin	chu 30077, Taiwan, R.O	.C,
(referred to as "ASSIGNEE"below) to acknowledged, andfor other good ar		.00), the receipt of which is h	ereby
I hereby sell, assign and transfer to a the entire right, title and interest in a invention as above-identified applica- invention by the above application o substitutes, or extensions thereof, an	nd to any and all improvements this and, in and to, all Letters Parany continuations, continuation	which are disclosed in the atent to be obtained for said n-in-part, divisions, renewals,	
I hereby covenant that no assignme entered into which would conflict wit		ance has been or will be mad	e or
I further covenant that ASSIGNEE wand documents relating to said inversions and accessible to I and will to related thereto and will promptly exercise.	ntion and said Letters Patent and estify as to the same in any inter	d legal equivalents as may be ference, litigation proceeding	Э
representatives any and all papers, maintain, issue and enforce said ap- equivalents thereof which may be no IN WITNESS WHEREOF, I have he	plication, said invention and said ecessary or desirable to carry ou	Letters Patent and said at the proposes thereof.	
Note: An application data sheet (PT inventive entity, must accompany the			

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NPO#ESM-P0113-USA:0 CUST#ES18011

F#NPO-P0002E-US1201 DSB0-108U006555

Docket No ESMP0113USA

LEGAL NAME OF INVENTOR(ASSIGNOR)

Inventor: Tse-Hua Yao

Date: >0190610

Signature: Tse-Hua Yao

COMBINE DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION USING AN APPLICATION DATA SHEET (37 CFR 1.76) AND ASSIGNMENT

Title of Invention:

E-FUSE BURNING CIRCUIT AND E-FUSE BURNING METHOD

As the below named inventor, I here this declaration is directed to:	by declare that:		
☑ The attached application, or			
☐ United States application nu	mber	filed on	, or
☐ PCT international application	number	filed on	
The above-identified application was	made or authorized to be mad	e by me.	
I believe that I am the original inventage application.	or or an original joint inventor o	f a claimed invention in th	ne
I hereby acknowledge that any willfu under18 U.S.C. 1001 by fine or impri			
In consideration of the payment by	Elite Semiconductor Mer Technology Inc.	mory having a post	al address of
No 23, Industry E. Road IV, H	sinchu Science Park, Hsir	nchu 30077, Taiwan,	R.O.C.
(referred to as "ASSIGNEE"below) to acknowledged, andfor other good ar	o I of the sum of One Dollar (\$ ' ad valuable consideration.	1.00), the receipt of which	n is hereby
I hereby sell, assign and transfer to a the entire right, title and interest in a invention as above-identified application invention by the above application of substitutes, or extensions thereof, an	nd to any and all improvements ition and, in and to, all Letters F r any continuations, continuatio	which are disclosed in the Patent to be obtained for a n-in-part, divisions, renev	ne said vals,
I hereby covenant that no assignmentered into which would conflict with		ance has been or will be	made or
I further covenant that ASSIGNEE w and documents relating to said inver known and accessible to I and will te related thereto and will promptly exe	ntion and said Letters Patent an estify as to the same in any inte	nd legal equivalents as m rference, litigation proces	ay be
representatives any and all papers, i maintain, issue and enforce said app equivalents thereof which may be no IN WITNESS WHEREOF, I have he	olication, said invention and sai ecessary or desirable to carry o	d Letters Patent and said ut the proposes thereof.	ı
Note: An application data sheet (PTo inventive entity, must accompany the			

Page 3 of 4

NPO#ESM-P0113-USA:0 CUST#ES18011 F#NPO-P0002E-US1201 DSB0-108U006555

Docket No ESMP0113USA

LEGAL NAME OF INVENTOR(ASSIGNOR)

Inventor: Yi-Fan Chen

Date: >019.6.>0

Signature: YI FAN CHEN

Page 4 of 4

NPO#ESM-P0113-USA:0 CUST#ES18011

RECORDED: 09/19/2019

F#NPO-P0002E-US1201 DSB0-108U006555

PATENT REEL: 050438 FRAME: 0920